## High Current Effects at NSLS-II

Boris Podobedov for Alexei Blednykh, Scott Berg, Michael Blaskiewicz, Samuel Krinsky, Nikolay Malitsky, Christoph Montag, James Rose, Nathan Towne, Fuhua Wang (MIT-BATES), Jiunn-Ming Wang, Li-Hua Yu

**Brookhaven National Laboratory** 

#### FLS Workshop, DESY, Hamburg May 16, 2006





# **Outline and Scope**

- Scope of this talk
- Motivation
- Touschek lifetime new regime
- IBS results and questions
- Impedance budget (ID chambers)
- The rest & status review
- Summary and conclusions

Parameter Goals for NSLS-II  
I = 500 mA ( 0.5 mA/bunch )  
$$\epsilon_x = 0.5-1 \text{ nm}$$
  
 $\epsilon_y = 1 \text{ Angstrom}/4\pi$   
 $\delta E/E = 0.1 \%$ 

# Lifetime & Collective Effects

#### Become harder with higher brightness

small bunch in all 6Dhigh currentmany small gap IDs

 $\Rightarrow$ 

Lower lifetime & instability thresholds

**NSLS-II** 

 $\sqrt{}$ 

#### Known solutions

- Topoff injection (lifetime => radiation)
- Harmonic RF
- Z( $\omega$ ) minimization (HOM-damped RF, BB minimization,...) $\checkmark$
- Multi-bunch feedback systems

#### Challenges

- need  $|Z/n| < 0.5 \Omega$  for MW threshold in multi-bunch
- TMCI due to resistive wall from small gap IDs

Single bunch instabilities become most challenging esp. at medium energy



Baseline for NSLS-II: 1.5 GHz SC harmonic cav.

#### 3

## Lifetime Limiting Mechanisms

- Quantum not a problem
- Gas Elastic

Vertical acceptance due to MGUs (gap = 2b = 5mm, L = 5m) is A ~ 1  $\mu$ m-rad

$$\frac{1}{\tau_{\text{scat}}} = \frac{4r_{\text{e}}^2 Z^2 \pi nc}{2\gamma^2} \left[ \frac{\langle \beta_x \rangle \beta_{x,\text{max}}}{a^2} + \frac{\langle \beta_y \rangle \beta_{y,\text{max}}}{b^2} \right] \implies \tau_{\text{scat}} \approx 24 \text{ hours}$$
(a) 1 nTorr N<sub>2</sub>

Gas – Bremsstrahlung

Gas contributions to lifetime are small It's now all about Touschek

## **Touschek Lifetime Basics**

For flat and transversely non-relativistic beams (works well for NSLS-II)



• Decay is non-exponential, but is assumed linear for frequent topoff

- Energy spread dependence (through dispersion) is typically weak
- Touschek is peak current effect, i.e.  $\tau_{tous_{1/2}} \sim \sigma_z/N_b$

#### **Touschek Scaling with Emittance – New Regime**



# Touschek Lifetime vs. Acceptance and Total Lifetime



- Most calcs. for bare lattice w/o apertures. Effect of IDs included "by hand" in ZAP
- ZAP, SAD & MAD results agree
- Work in progress to consider other effects, i.e. lattice nonlinearities,  $\alpha_2$ , effects of IDs, errors & coupling correction, bunch lengthening, etc.
- Lattice-dependent momentum aperture being done by 6D tracking (Elegant and TRACY2)

# Multiple Intra-Beam Scattering (IBS)



- ε<sub>x</sub>, δE/E, τ<sub>rad</sub>, scaled "by hand" for radiation loss
- Bare lattice case agrees with SAD and Bane's apprx.
- Emittance blow-up: < 50% @ 3 GeV, < 15% @ 3.5 GeV
- Smaller  $\varepsilon_x$  offset by shorter  $\tau_{rad}$
- Will re-run with 3D code SAD with IDs and vertical η

# Multiple Intra-Beam Scattering (IBS)



- ε<sub>x</sub>, δE/E, τ<sub>rad</sub>, scaled "by hand" for radiation loss
- Bare lattice case agrees with SAD and Bane's apprx.
- Emittance blow-up: < 50% @ 3 GeV, < 15% @ 3.5 GeV
- Smaller  $\varepsilon_x$  offset by shorter  $\tau_{rad}$
- Will re-run with 3D code SAD with IDs and vertical η

# **IBS with Bunch Lengthening**



- ZAP calcs shown (a) 1.4 MV loss/Trn
- Harmonic RF (HRF) x2-3 in  $\sigma_{z}$
- Ignore PWD
- IBS is small
- Will re-run with 3D code SAD with IDs and vertical  $\eta$

#### **NSLS-II Impedance Budget**

Table 1: Budget impedance of the NSLS-II ring components							
Components	ImZ <sub>y</sub> (ω→0), Ω/m	ImZ <sub>x</sub> (ω→0), Ω/m	$\frac{\mathrm{Im} Z_{\parallel}(\omega)}{\omega} \omega_{0} Q_{BB}$	ky, V/pC/m	k <sub>z</sub> , V/pC/m	k <sub>ioss</sub> , V/pC	Estimated number of components
1. Tapered elliptic vacuum chamber	3·10 <sup>3</sup> (75 µm)	965 (100 µm)	30·10 <sup>-6</sup> (100 µm)	86 (75 µm)	30	0.311·10 <sup>-3</sup>	10
2. Room Temperature MGU	58·10 <sup>3</sup> (500µm)	3.9·10 <sup>3</sup>	130·10 <sup>-6</sup> (500 µm)	505	112		10
3. Shielded RTMGU				GD	FIDL Results		
Litype Gapt	22·10 <sup>3</sup> (500μm) 14·10 <sup>3</sup> (120μm)	3·10 <sup>3</sup> (500μm) 1.5·10 <sup>3</sup> (120μm)	127·10 <sup>-6</sup> (500μm) 49·10 <sup>-6</sup> (120μm)	245	73		
4. Dipole vacuum chamber	1.1	17.6	0.073.10-6	4.6·10 <sup>-2</sup>	0.68	0.240·10 <sup>-3</sup>	72

11

Alexei Blednykh

#### NSLS-II Impedance Budget (Cont.)

-									-
	Components	ImZ <sub>y</sub> (ω→0), Ω/m	ImZ <sub>x</sub> (ω→0), Ω/m	$\frac{\mathrm{Im} \mathbb{Z}_{\ }(\omega)}{\omega} \omega_0 \mathbb{Q}_{BF}$	k <sub>x</sub> , V/pC/m	k <sub>x</sub> , V/ <u>pC</u> /m	k <sub>loss</sub> , V/ <u>pC</u>	Estimated number of components	
	5. Photons absorber	1.1	17.2	0.037 <b>·</b> 10 <sup>-6</sup>	2.9·10 <sup>-2</sup>	0.43	0.139·10 <sup>-3</sup>	120	
	6. BPM	54	42.1		1.1	0.87	19.971·10 <sup>-3</sup>	300	
	7. Elliptic bellows	8.9·10 <sup>3</sup>	4.6·10 <sup>3</sup>		126.2	74.64			
1	8. Transition from absorber to regular vacuum chamber	9.8·10 <sup>3</sup>	??	1140·10⁵ (bellows)	55	10.4		48	Alexei Blednyk

### Geometric Impedance of Small Gap ID Chambers



Impedance of NSLS-II ID tapers is <10 k $\Omega$ /m, and is less than Res. Wall. Need to understand higher measured numbers from some other LS.

# TMCI due to MGU Resistive Wall

- TMCI driven by small undulator gaps is a concern:  $Z_{\perp}(\omega)/L \sim a^{-3}$ • Threshold:  $\Delta V_y = \frac{I_{th} W_{\perp}^{\max} \beta_y^* L}{2\omega_{rm} E/e} = V_s$ 175  $W_{\perp}\left[\frac{V}{pC m^2}\right]$ 150 • NSLS-II undulators:  $\rho[arb]$ 125 warm assume 100 m of Cu pipe 5 mm Ø 100 $W_{\cdot}^{\max}$  $I_{th} \approx 1 \, mA \,/ \, bunch$ warm 50 cryo  $I_{H} \approx 4 \, mA / bunch$ Cryo 4 <sup>~</sup> 3 S/σ, 1 2 3 2 1  $\beta_v = 5$  m,  $\sigma_z = 3.3$  mm,  $\nu_s = 0.005$
- Also confirmed by simulations (MOSES, tracking)
- This does not change significantly with harmonic RF

At operating value of 0.5 mA/bunch, we are below TMCI threshold

## **Other Issues Studied**

- RF cavity and resistive wall driven coupled bunch instabilities
- Damping of transverse couple bunch inst. with positive chromaticity
- Beam dynamics with harmonic RF
- TMCI particle tracking with harmonic RF included
- Micro-Wave instability (Tracking, Oide-Yokoya method, Fokker-Plank solver)
- Coherent synchrotron radiation instability
- Resistive heat of (SC) undulator chambers

# None of these presently appear showstoppers for NSLS-II design

# **Summary and Conclusions**

- NSLS-II is optimized for nominal multi-bunch operation, and uses many known solutions to ease high current effects
- NSLS-II single bunch and high current goals appear to be achievable
- Touschek lifetime of a few hours is in the new regime, experimental confirmation would be welcome. Tracking (Elegant, TRACY2) in progress for momentum acceptance, loss distribution, etc.
- (Multiple) IBS appears insignificant
- Transverse couple bunch instability may require feedback
- Impedance budget work is ongoing. Results will feed into Elegant and other codes, as well as will be re-evaluated analytically
- Would like collaboration with other facilities on understanding measurement results due to small gap ID chambers

# EXTRA

#### **Concluding Remarks**

- Single bunch and average current goals appear to be achievable
- Transverse coupled bunch instability may require feedback
- We are facing a theoretical puzzle in regard to microwave instability threshold, which we are working to resolve. However, the threshold is above the 0.4ma required.
- At the moment we are estimating instability thresholds based on the impedances observed at ESRF and APS.
- We are calculating the NSLS-II impedance budget. Once this is done, we will estimate the instability thresholds using the calculated impedance.
- Realistic calculation of the Touschek lifetime is of critical importance. Work on this problem is underway using both TRACY2 and ELEGANT.

#### MGU-driven Transverse Single Bunch Instabilities

- TMCI and/or TMW instabilities are observed at many synchrotrons and may limit single bunch current
- Generally both the geometric (transitions) and resistive wall wakes contribute
- For typical short, warm, MGUs the geometric wake exceeds the resistive wall

Geometric wake will be made small with shallow taper and optimal transition design to minimize the geometric contribution to the impedance and avoid the TMCI instability





#### Resistive Wall for Normal and Anomalous Skin Effect Regimes

- (Warm) Permanent Magnet MGUs (Cu @ 300 K) Normal Skin Effect:  $l/\delta_{sk} << 1 \implies Z_{s\_normal}(\omega) = \sqrt{\frac{\omega\mu}{2\sigma_{cond}}}(1-i)$
- (Cold) Superconducting SCUs (Cu @ 4.2 K) Extreme Anomalous Skin Effect:

$$l/\delta_{\rm sk} >> 1 \implies Z_{s\_extreme}(\omega) = A\omega^{2/3}(1-i\omega)$$
  
with A=0.033 ps<sup>5/3</sup> V/pC for Cu, independent of  $\sigma_{cond}$  (RRR)

We derived most resistive wall related quantities (short/long range wakes, loss/kick factors, instability thresholds, etc.)



(3)

## **Resistive Wall Heating**

$$P_L = 5.6 \times 10^{-5} \frac{I_{av} \lambda_{RF}}{a \sigma_z^{3/2}}$$

 $P_{L} = 4.2 \times 10^{-6} \frac{I_{av}^{2} \lambda_{RF}}{a \sigma^{5/3}}$ 

P/L ~ 28 W/m (warm Cu), or 140 W for 5 m undulator, easily handled

(Cold) Superconducting SCUs (Cu @ 4.2 K)

average current  $I_{av}$ rms length  $\sigma_z$ RF wavelength  $\lambda_{RF}$  60 cm half ID gap a 2.5 mm off-center error  $\Lambda$ 

500 mA 3.3 mm 0.5 mm

Conservative Estimate\*: P/L ~ 5 W/m (cold Cu), or 25 W for 5 m undulator, exceeds off-the-shelf single cryocooler capacities but could be handled by individual refrigerator. Harmonic RF may reduce this a factor of ~ 6.

> \*Ignore bunch lengthening, ignore chamber ellipticity, allow for  $\Delta$  by  $a \rightarrow a - \Delta$ , 4/5 RF buckets filled  $\rightarrow +25\%$

### Synchrotron Radiation Heat Load on Undulator



- Undulator radiation has finite opening angle
- Small fraction hits the cold bore
- P ~ 40 W for 5 m undulator



Warm MGU – easily handled Cold SCU - exceeds off-the-shelf single cryo-cooler capacities but could be handled by individual refrigerator.

# Longitudinal Single Bunch Instabilities

- Microwave  $\lambda_{inst} / \sigma_z << 1$ 
  - Boussard criterion  $|Z_n/n| < 0.1 \Omega < low!$
  - Lower  $|Z_n/n|$  are believed achievable (i.e. ILC DR)
  - However, Boussard criterion is conservative
  - Harmonic RF (and PWD) increases the threshold  $\sim \sigma_z$
- Mode-Coupling  $\lambda_{inst} / \sigma_z > \sim 1$ 
  - Scaling NSLS ring  $Z(\omega)$  gives  $I_{total} > 1$  A
  - Scaling is very simplistic
     =>Z(ω) budget is needed
  - Harmonic RF increases the threshold but slower than ~σ<sub>z</sub>



- Self-stabilize through increase in  $\delta E/E$
- Not significantly driven by MGUs

#### Tight impedance control will be required

Use of a bunch lengthening Landau cavity can increase Touschek lifetime, raise microwave instability threshold and decrease intrabeam scattering. Initial estimates indicate we can increase bunch length by factor of ~2.5



Figure 1: Line densities of bunches uniformly sampled along the length of an 80%-fill bunch train. The leading edge of each bunch is on the right and the progression of leading bunches to trailing bunches is from left to right. Each bunch is normalized to unity with respect to ring azimuthal angle.



Figure 3: Line densities of unstretched (blue) and stretched (aqua) bunches in a uniform fill.

#### N. Towne

## Geometric Impedance of Axially Symmetric Tapers

• At low frequency shallow taper impedance is imaginary and small

**Z**(*ω*) ~ *i* θ, ( $\sigma_z >> a \theta$ )

• Analytical expressions exist for impedance in this (Yokoya) regime

NSLS-II 0.5 m ( $\theta$ =25 mrad) MGU tapers result in sufficiently low impedance to avoid MW and TMCI instabilities

$$|Z_{\parallel}/n|=0.2 \text{ m}\Omega \quad Z_{\perp}=1 \text{ k}\Omega/\text{m}$$

Estimates confirmed by simulation



Also considered elliptical chambers

 $Z_y$  grows factor of ~6 but still low enough for TMCI

#### New Results (Convex Structure)



Example:  $Z_x$  should be 0 (not 0.5) for a flat structure

•To confirm needed to extend the PT to higher orders

26

 $\leq wrong$